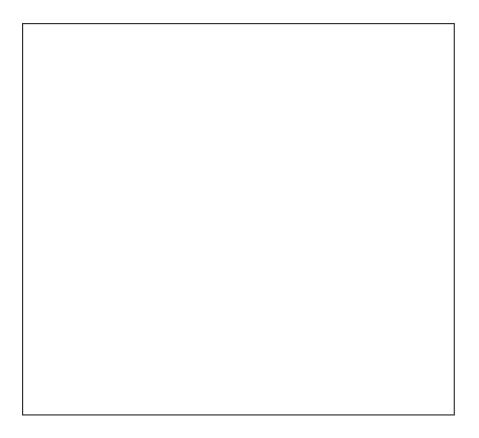


TABLE 1				
Variant	Label text			
001	ChangeMe!			
002	ChangeMe!			

PCB VIEWED FROM TOP SIDE	BOARD #: PMP9184	REV: A SVN REV		": Not In VersionControl			
IGNORE -> Top Overlay							
PLOT NAME = Top Assembly Drawing	GENERATED : 10/23/	2013 12:35:48	PM	TEXAS INSTRUMENTS			



PCB VIEWED FROM BOTTOM SIDE	BOARD #: PMP9184	REV: A	SVN REV:	: Not In VersionControl
	Bottom Overlay <- SAONDI			Bottom Ove
PLOT NAME = Bottom Assembly Drawing	GENERATED : 10/23/	2013 12:35:49	PM	TEXAS INSTRUMENTS

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